

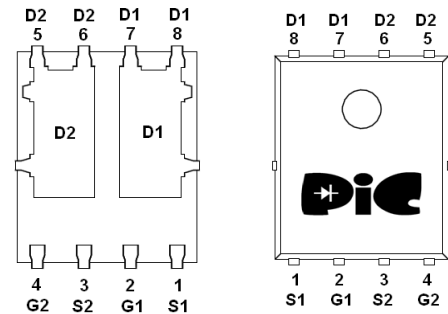
➤ General Description

This PAN79TY38AY Dual N-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent $R_{ds(On)}$ performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

➤ Feature

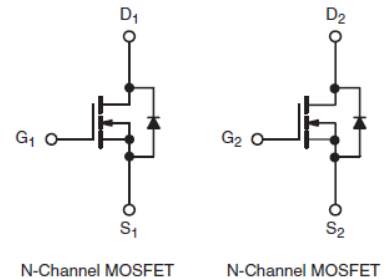
- Super Low Gate Charge
- 100% EAS Guaranteed
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology
- DFN5x6B-EP2 package design

➤ DFN5X6B-EP2



➤ Application

- DC/DC Primary Side Switch
- Industrial Synchronous
- Rectification Load Switch
- DC/DC Converters



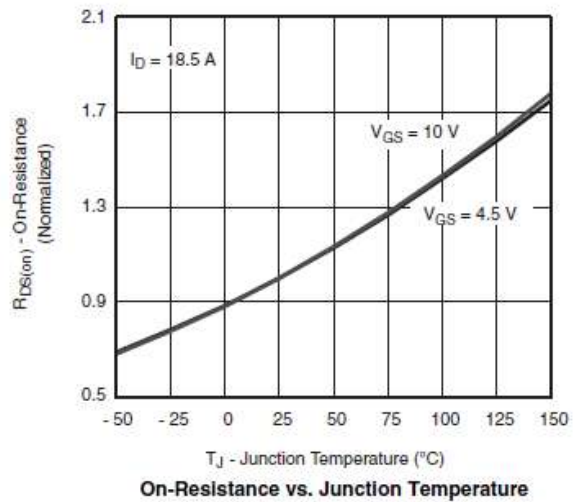
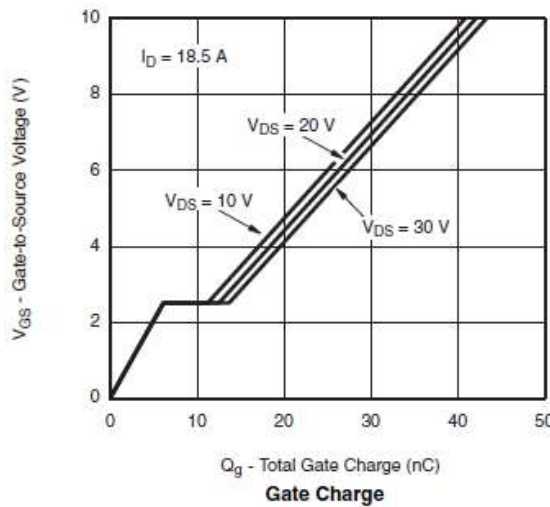
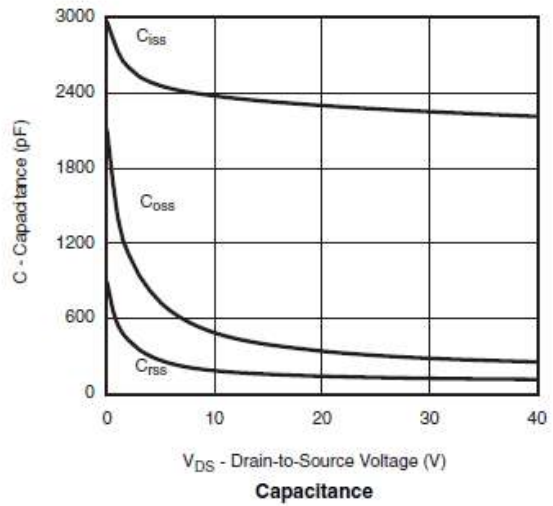
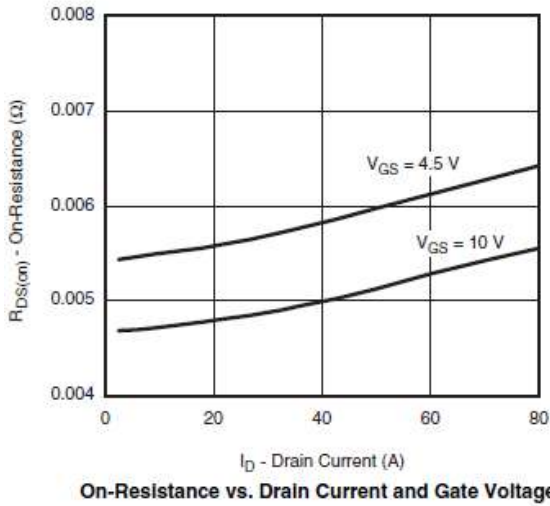
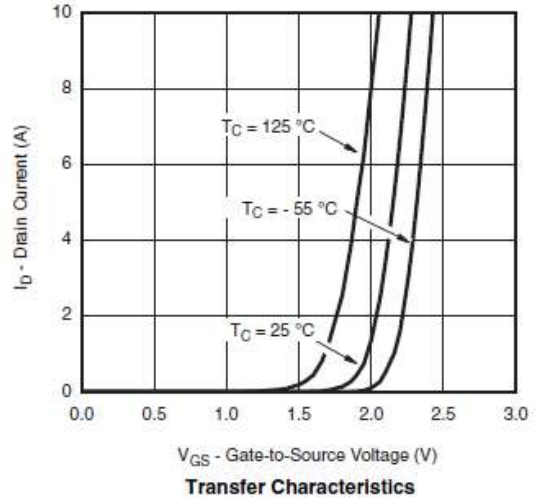
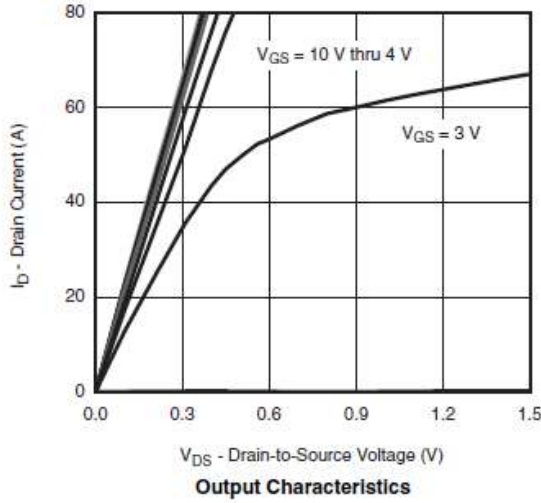
➤ Absolute Maximum Ratings

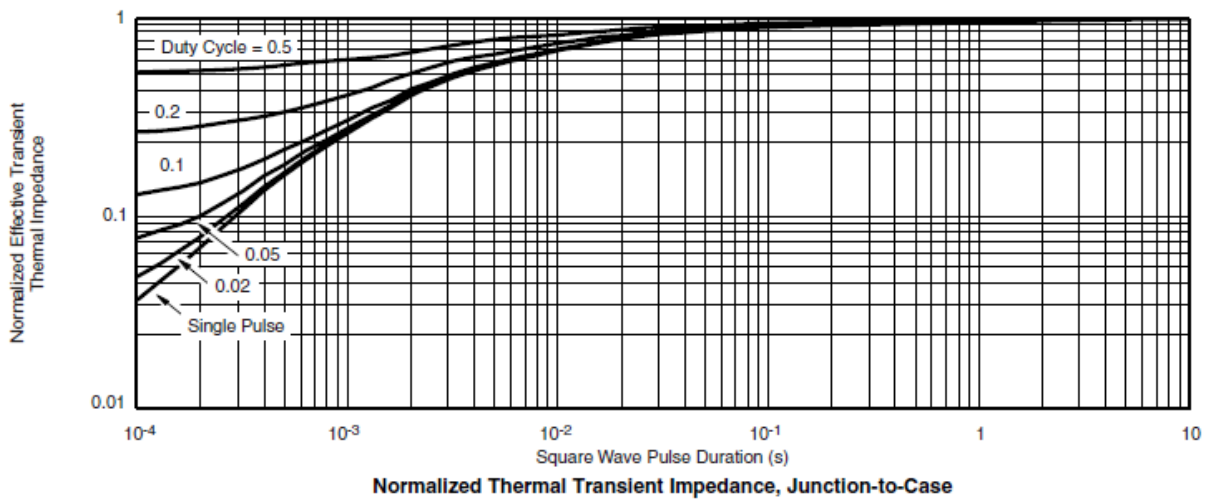
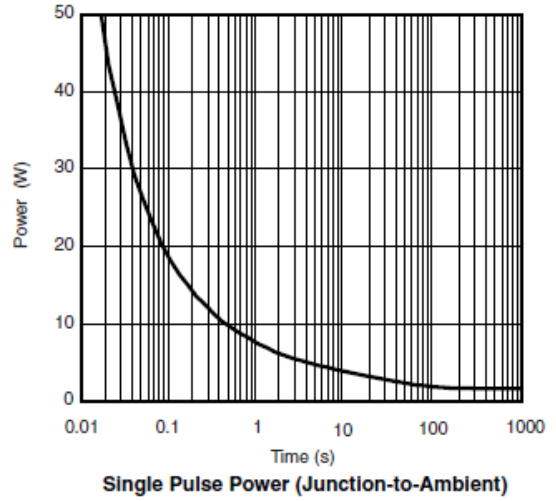
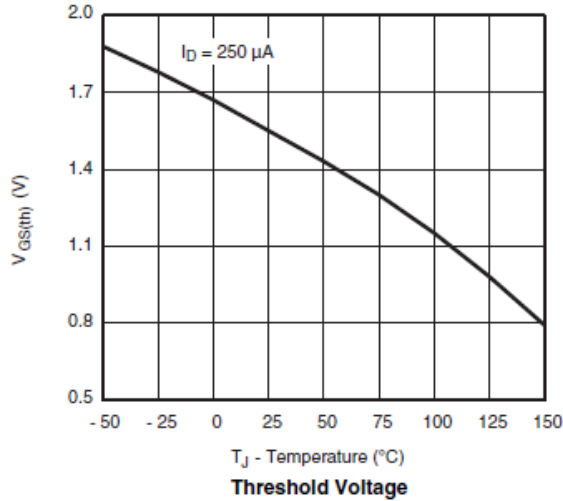
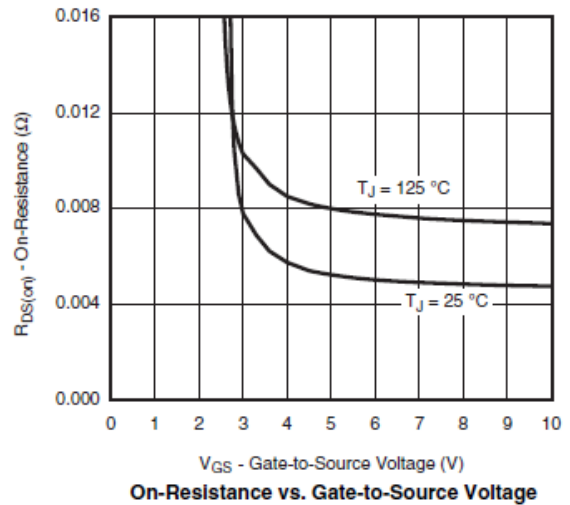
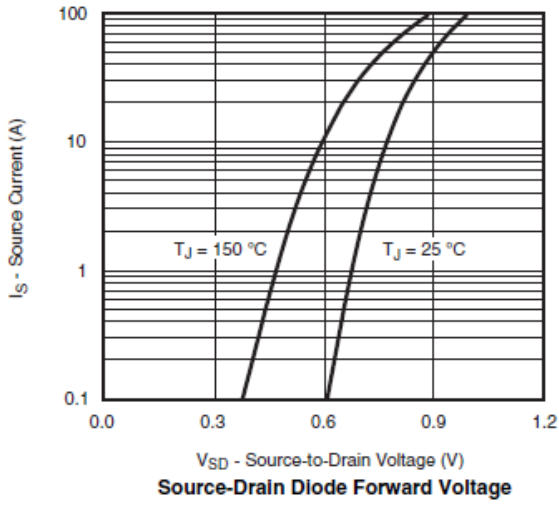
Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	40	V
Gate –Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current($T_J=150^\circ C$)	I_D	$T_C=25^\circ C$	60
		$T_C=85^\circ C$	60
		$T_A=25^\circ C$	20
		$T_A=85^\circ C$	16
Pulsed Drain Current	I_{DM}	80	A
Continuous Source Current(Diode Conduction)	I_S	$T_C=25^\circ C$	38
		$T_A=25^\circ C$	2.9
Power Dissipation	P_D	$T_C=25^\circ C$	46
		$T_C=85^\circ C$	29
		$T_A=25^\circ C$	3.5
		$T_A=70^\circ C$	2.2
Operating Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{STG}	-55/150	$^\circ C$
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	62.5	$^\circ C/W$

➤ **Electrical Characteristics ($T_A=25^\circ C$ Unless otherwise noted)**

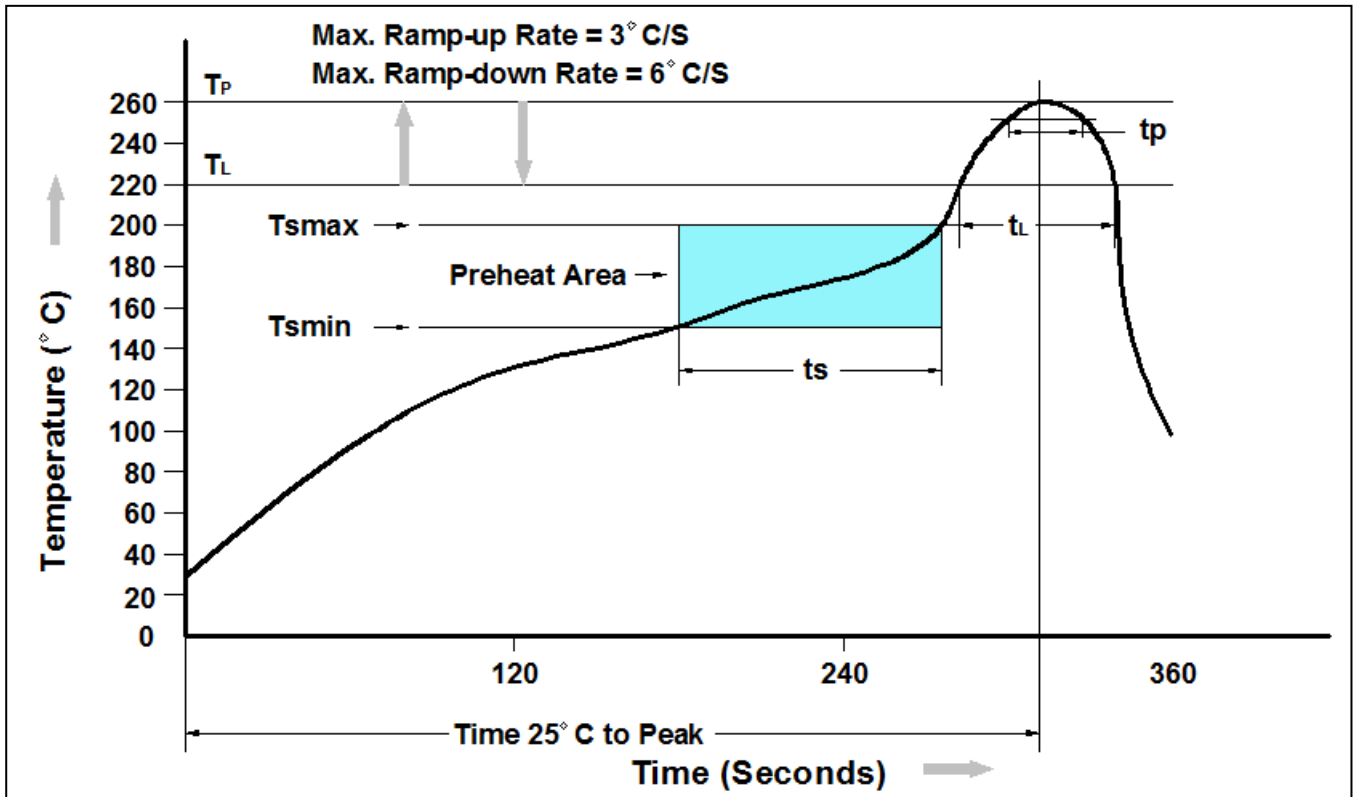
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	40			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0		2.5	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=32V, V_{GS}=0V$			1	uA
		$V_{DS}=32V, V_{GS}=0V$ $T_J=85^\circ C$			10	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \geq 5V, V_{GS}=10V$	20			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=18A$		12.5	14	m Ω
		$V_{GS}=4.5V, I_D=15A$		13.5	16	
Forward Transconductance	g_{FS}	$V_{DS}=15V, I_D=20A$		70		S
Diode Forward Voltage	V_{SD}	$I_S=5A, V_{GS}=0V$		0.8	1.3	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=20V, V_{GS}=4.5V$ $I_D \equiv 18.5A$		21	32	nC
Gate-Source Charge	Q_{gs}			6.2		
Gate-Drain Charge	Q_{gd}			6.2		
Input Capacitance	C_{iss}	$V_{DS}=20V, V_{GS}=0V$ $f=1MHz$		2300		pF
Output Capacitance	C_{oss}			340		
Reverse Transfer Capacitance	C_{riss}			140		
Turn-On Time	$t_{d(on)}$	$V_{DD}=20V, R_L=2.0\Omega$ $I_D \equiv 10A, V_{GEN}=10V$ $R_G=1.0\Omega$		10	20	ns
	t_r			10	20	
Turn-Off Time	$t_{d(off)}$			30	55	
	t_f			10	20	

➤ Typical Characteristics





➤ Recommend IR Reflow Soldering Thermal Profile

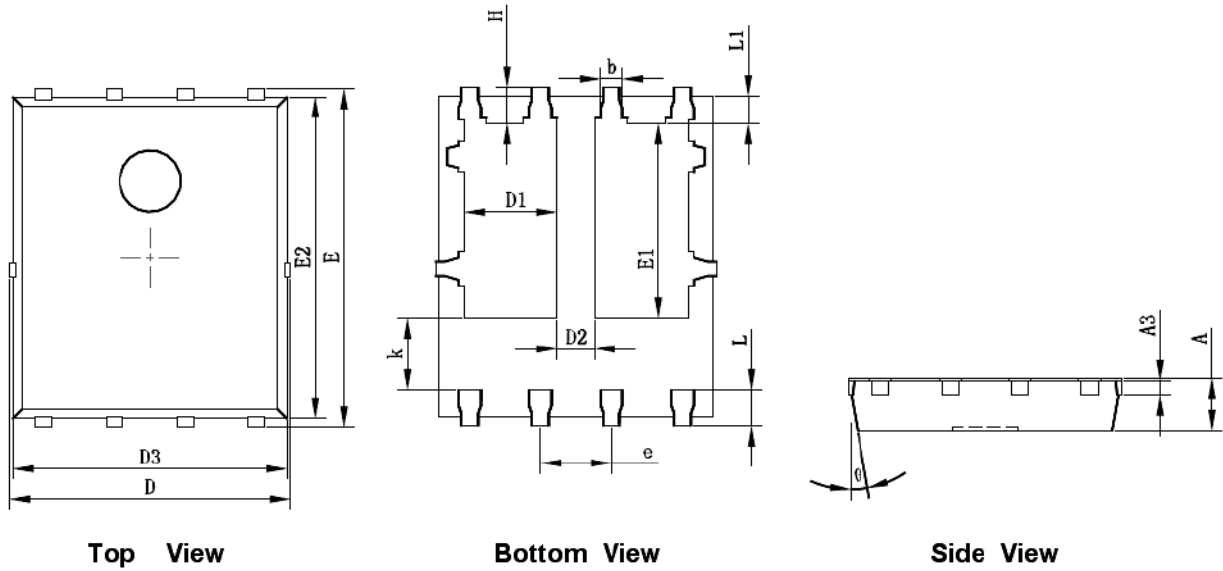


Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	150°C
Temperature Max. (T _{smax})	200°C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds
Average Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

➤ Ordering Information

Part Number	Description	Quantity
PAN79TY38AY	DFN5X6B-EP2 Reel	2500 pcs

➤ Package Information (DFN5X6B-EP2)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254 REF.		0.010 REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	1.470	1.870	0.058	0.074
D2	0.470	0.870	0.019	0.034
E1	3.375	3.575	0.133	0.141
D3	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270 TYP.		0.050 TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°

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